IPC-TM-650
Number 2.4.28.1

ADOPTION NOTICE

IPC-TM-650, Number 2.4.28.1, “Adhesion, Solder Resist (Mask) Tape Test Method”, was adopted on 24 May 2004, for use by the Department of Defense (DoD). Proposed changes by DoD activities must be submitted to the DoD Adopting Activity: Defense Logistics Agency, Defense Supply Center, Columbus, ATTN: DSCC-VAC, P.O. Box 3990, Columbus, OH 43216-5000. Copies of this standard may be purchased from the Association Connecting Electronics Industry, 2215 Sanders Road, Suite 200 South, Northbrook, IL 60062-6135, URL: http://www.ipc.org.

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(Project 5998–0176)

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